

Vishay Siliconix

## **Dual N-Channel 1.2-V (G-S) MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>g</sup>	Q <sub>g</sub> (Typ.)		
8	0.113 at $V_{GS} = 4.5 \text{ V}$	1.5 <sup>a</sup>			
	$0.138 \text{ at V}_{GS} = 2.5 \text{ V}$	1.5 <sup>a</sup>			
	$0.190 \text{ at V}_{GS} = 1.8 \text{ V}$	1.5 <sup>a</sup>	1.5 nC		
	$0.280 \text{ at V}_{GS} = 1.5 \text{ V}$	1.0			
	$0.480$ at $V_{GS} = 1.2 \text{ V}$	0.3			

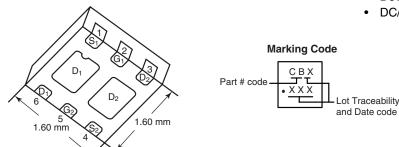
### **FEATURES**

- Halogen-free
- TrenchFET<sup>®</sup> Power MOSFET
- New Thermally Enhanced PowerPAK<sup>®</sup> SC-75 Package
  - Small Footprint Area
  - Low On-Resistance



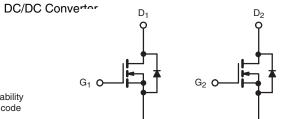
RoHS

## PowerPAK SC75-6L-Dual



## APPLICATIONSLoad Switch, PA

Load Switch, PA Switch and Battery Switch for Portable Devices



N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	8	V		
Gate-Source Voltage		V <sub>GS</sub>			± 5
	T <sub>C</sub> = 25 °C		1.5 <sup>a</sup>		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	ls	1.5 <sup>a</sup>		
Continuous Brain Current (1) = 130 G)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	1.5 <sup>a, b, c</sup>		
	T <sub>A</sub> = 70 °C		1.5 <sup>a, b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	6		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	lo	1.5 <sup>a</sup>		
	T <sub>A</sub> = 25 °C	ls —	0.9 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		3.1		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	2.0	w	
	T <sub>A</sub> = 25 °C	' D	1.1 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		0.7 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260	7	

Ordering Information: SiB914DK-T1-GE3 (Lead (Pb)-free and Halogen-free) N-Channel MOSFET

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 5 s	$R_{thJA}$	90	115	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	$R_{thJC}$	32	40		

#### Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s
- d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 125 °C/W.
- g. Based on  $T_C = 25$  °C.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					L		
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	8			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	T.		8.3			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 2.1		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.35		0.8	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$			± 100	nA	
Zovo Coto Voltogo Dielia Originat	I <sub>DSS</sub>	V <sub>DS</sub> = 8 V, V <sub>GS</sub> = 0 V			1	μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = 8 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	6			Α	
		$V_{GS} = 4.5 \text{ V}, I_D = 2.5 \text{ A}$		0.090	0.113		
		V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 2.2 A		0.110	0.138		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 1.9 A		0.150	0.190	Ω	
		V <sub>GS</sub> = 1.5 V, I <sub>D</sub> = 1.0 A		0.200	0.280		
		V <sub>GS</sub> = 1.2 V, I <sub>D</sub> = 0.1 A		0.280	0.480		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 4 V, I <sub>D</sub> = 2.5 A		10		S	
Dynamic <sup>b</sup>	l l						
Input Capacitance	C <sub>iss</sub>			125		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 4 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		68			
Reverse Transfer Capacitance	C <sub>rss</sub>			35			
Total Cata Charge	Q <sub>g</sub> -	$V_{DS} = 4 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 2.5 \text{ A}$	1.7	2.6			
Total Gate Charge				1.5	2.3	nC	
Gate-Source Charge		$V_{DS} = 4 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 2.5 \text{ A}$		0.25			
Gate-Drain Charge	$Q_{gd}$			0.25			
Gate Resistance	$R_g$	f = 1 MHz	0.7	3.5	7.0	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			4	8		
Rise Time	t <sub>r</sub>	$V_{DD} = 4 \text{ V}, R_L = 2 \Omega$		7	14	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 2.0 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		22	33		
Fall Time	t <sub>f</sub>			9	19		
<b>Drain-Source Body Diode Characterist</b>	ics						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			1.5 <sup>c</sup>	А	
Pulse Diode Forward Current	I <sub>SM</sub>				6	^	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 2.0 A, V <sub>GS</sub> = 0 V		0.7	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			10	15	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$I_F = 2.0 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		2	4	nC	
Reverse Recovery Fall Time	ta			4		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			6			

#### Notes:

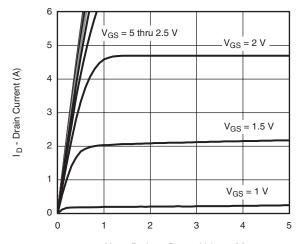
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Package limited.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



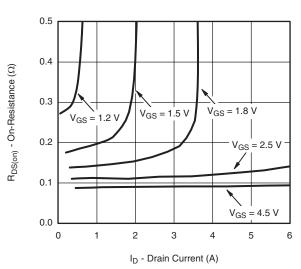
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

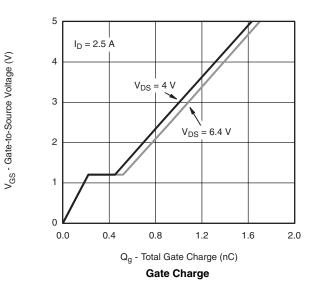


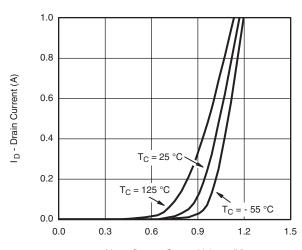
V<sub>DS</sub> - Drain-to-Source Voltage (V)

#### **Output Characteristics**



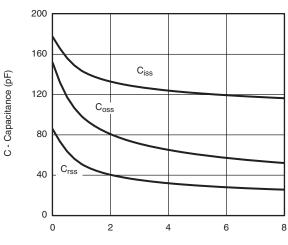
On-Resistance vs. Drain Current and Gate Voltage





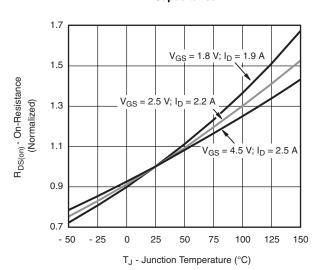
V<sub>GS</sub> - Gate-to-Source Voltage (V)

#### **Transfer Characteristics**



V<sub>DS</sub> - Drain-to-Source Voltage (V)

#### Capacitance

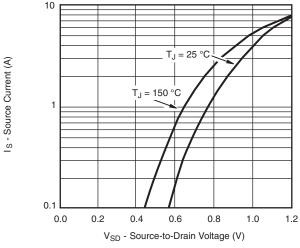


On-Resistance vs. Junction Temperature

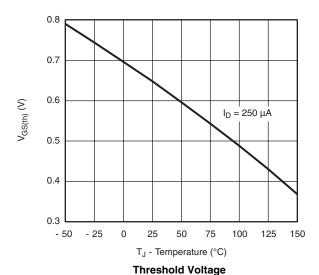
## SiB914DK

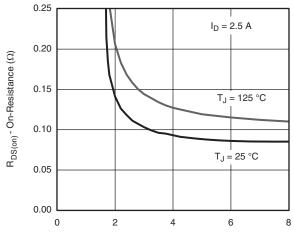
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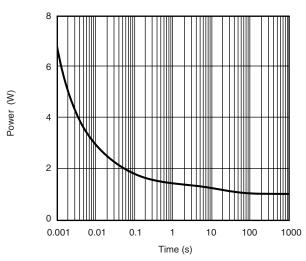


### Soure-Drain Diode Forward Voltage

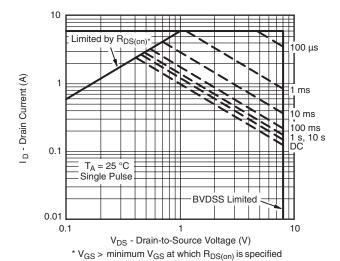




V<sub>GS</sub> - Gate-to-Source Voltage (V) On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

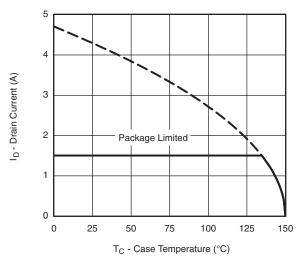


Safe Operating Area, Junction-to-Case

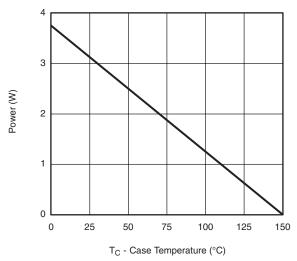


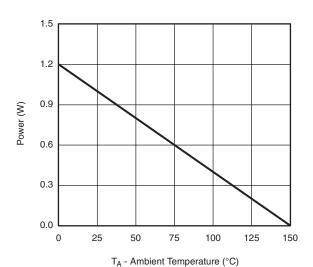
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### **Current Derating\***





Power Derating, Junction-to-Case

Power Derating, Junction-to-Ambient

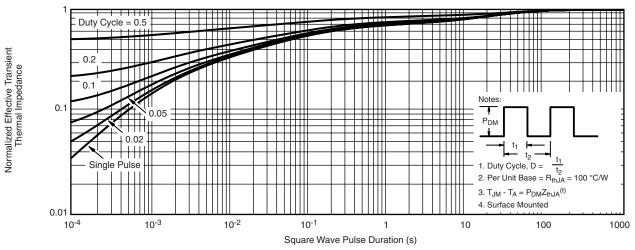
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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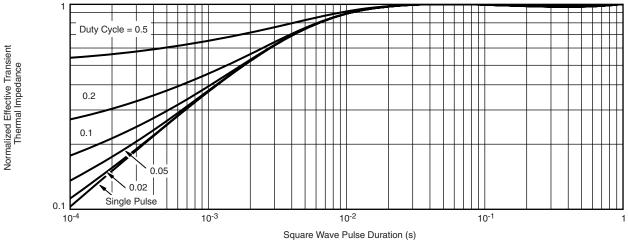
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



## Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?68792">http://www.vishay.com/ppg?68792</a>.





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